A T 2 4 C S W 0 4 0 - U U M 0 B - T

Shipping Carrier Option
T = Tape and Reel

Product Family
24CS = I²C Compatiable
Serial EEPROM with
a Security Register

Product Variation
0B = Backside Coated WLCSP Package

Device Density & Feature
W04 = 4-Kbit with
Software Write Protection
W08 = 8-Kbit with
Software Write Protection

Operating Voltage
M = 1.7V to 3.6V

**Package Device Grade or
Wafer/Die Thickness**
U = Industrial Temperature Range
(-40°C to +85°C)
11 = 11 mil Wafer Sale Thickness

**Hardware Slave Address
(4-Kbit Device)**
0 = A_2,A_1 Slave Address, 00b
2 = A_2,A_1 Slave Address, 01b
4 = A_2,A_1 Slave Address, 10b
6 = A_2,A_1 Slave Address, 11b

Package Option
U = 2 x 2 Grid Array, WLCSP
WW = Wafer Sale

**Hardware Slave Address
(8-Kbit Device)**
0 = A_2 Slave Address, 0b
4 = A_2 Slave Address, 1b

Note: Contact your local sales representative for hardware slave address availability.